

### ESDAxxxP6

### Transil™ array for ESD protection

### Main applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Servers
- Printers
- Communication systems and cellular phones
- Video equipment

These devices are particularly adapted to the protection of symmetrical signals.

#### **Features**

- 4 / 5 Unidirectional (ESDA6V1P6 and ESDA6V1-5P6) and Bidirectional (ESDA14V2BP6 and ESDA25-4BP6) Transil functions
- Breakdown voltage: V<sub>BR</sub> = 6.1 V min., 14.2 V min. and 25 V min.
- Low leakage current: < 500 nA (ESDA6V1P6 / ESDA6V1-5P6) < 1 µA (ESDA14V2BP6 and ESDA25-4BP6)
- Very small PCB area < 2.6 mm<sup>2</sup>

### **Description**

The ESDAxxxP6 are monolithic arrays designed to protect up to 5 lines against ESD transients.

These devices are ideal where board space saving and reduced line capacitance are required.

#### **Benefits**

- High ESD protection level
- High integration
- Suitable for high density boards

### Complies with the following standards:

IEC61000-4-2 level 4: 15 kV (air discharge)

8 kV (contact discharge)

MIL STD 883E-Method 3015-7: class3

25 kV (Human Body Model)





SOT-666IP (Internal pad) ESDA6V1P6 ESDA6V1-5P6 SOT-666 ESDA14V2BP6 ESDA25-4BP6

#### **Order codes**

Part Number	Marking
ESDA6V1P6	В
ESDA6V1-5P6	С
ESDA14V2BP6	Α
ESDA25-4BP6	V

Figure 1. ESDA6V1P6 functional diagram

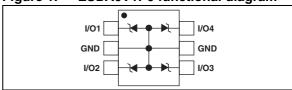


Figure 2. ESDA6V1-5P6 functional diagram

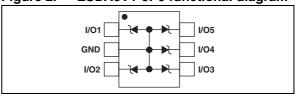
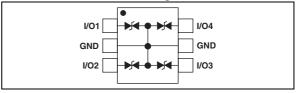


Figure 3. ESDA14V2BP6 and ESDA25-4BP6 functional diagram



TM: Transil is a trademark of STMicroelectronics

May 2007 Rev 3 1/8

Characteristics ESDAxxxP6

## 1 Characteristics

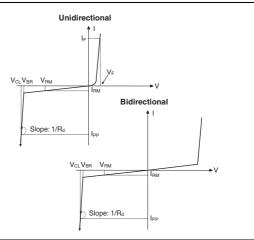
Table 1. Absolute Maximum Ratings  $(T_{amb} = 25^{\circ} C)$ 

	C (and						
Symbol	Paran	Value	Unit				
V <sub>PP</sub>	IEC 61000-4-2 level 4 standard air discharge contact discharge		±15 ±8	kV			
В	Peak pulse power (8/20 µs) (1) ESDA6V1P6 / ESDA6V1-5P6		150	w			
$P_{PP}$ $T_{j}$ initial = $T_{amb}$	$T_j$ initial = $T_{amb}$	ESDA14V2BP6 / ESDA25-4BP6	50	٧٧			
Tj	Junction temperature	150	°C				
T <sub>stg</sub>	Storage temperature range	-55 to +150	°C				
TL	Maximum lead temperature for soldering during 10 s at 5 mm for case			°C			
T <sub>op</sub>	Operating temperature range -			°C			

<sup>1.</sup> for a surge greater than the maximum values, the diode will fail in short-circuit.

**Table 2.** Electrical Characteristics  $(T_{amb} = 25^{\circ} C)$ 

	= ( · aiii
Symbol	Parameter
V <sub>RM</sub>	Stand-off voltage
V <sub>BR</sub>	Breakdown voltage
V <sub>CL</sub>	Clamping voltage
I <sub>RM</sub>	Leakage current
I <sub>PP</sub>	Peak pulse current
αΤ	Voltage temperature coefficient
V <sub>F</sub>	Forward voltage drop
С	Capacitance
R <sub>d</sub>	Dynamic resistance



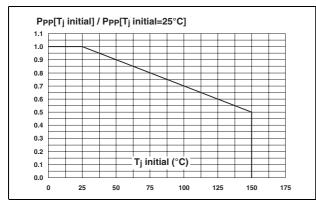
	V	3R		I <sub>RM</sub> @ V <sub>RM</sub>		R <sub>d</sub>	α <b>T</b>	С
Part Numbers	min.	max.	@ I <sub>R</sub>	max.		max.	typ.	typ.
Part Numbers	111111.	IIIax.		IIIax.				@ 0V
	V	V	mA	μΑ	V	Ω	10 <sup>-4</sup> /°C	рF
ESDA6V1P6	6.1	7.2	1	0.5	3	1.5	4	70
ESDA6V1-5P6	0.1	1.2	'	0.5	3	1.5	4	70
ESDA14V2BP6	14.2	14.2 10	18 1	1	12	1.5	5.8	25
L3DA14V2BF0	14.2	10		0.1	3	1.5	5.6	23
ESDA25-4BP6	25	30	1	1	24	1.7	7.3	22

**577** 

ESDAxxxP6 Characteristics

Figure 4. Peak power dissipation versus initial junction temperature

Figure 5. Peak pulse power versus exponential pulse duration  $(T_i initial = 25^{\circ} C)$ 



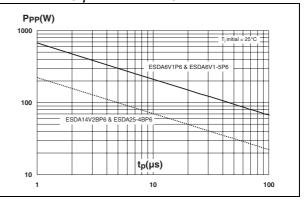
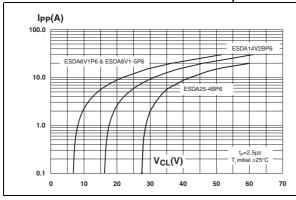


Figure 6. Clamping voltage versus peak pulse current ( $T_j$  initial = 25° C, rectangular waveform,  $t_p$  = 2.5  $\mu$ s)

Figure 7. Junction capacitance versus reverse applied voltage (typical values)



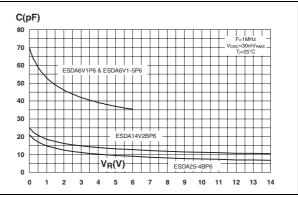
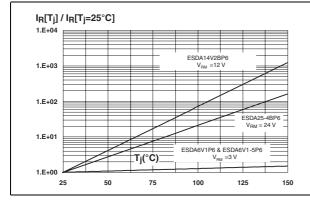


Figure 8. Relative variation of leakage current versus junction temperature (typical values)

Figure 9. Peak forward voltage drop versus peak forward current (typical values)



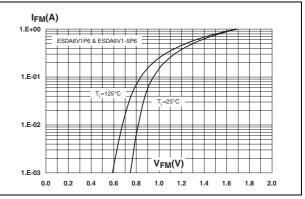
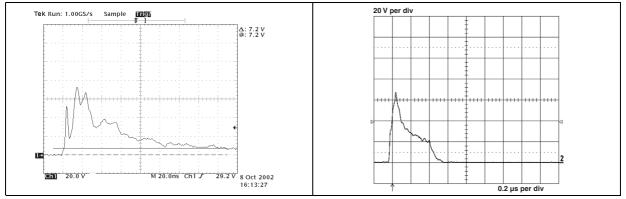
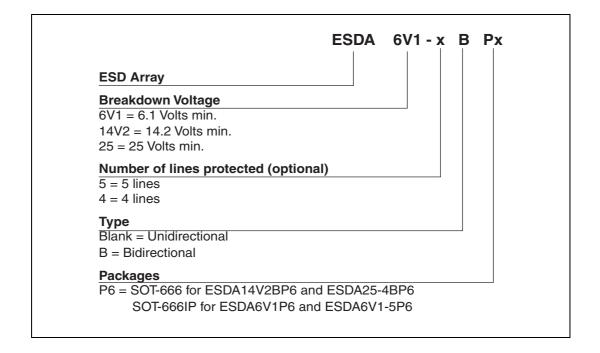


Figure 10. ESD response @ V<sub>PP</sub> = 15 kV air discharge (ESDA6V1-5P6)

Figure 11. ESD response @ V<sub>PP</sub> = 15 kV air discharge (ESDA25-4BP6)



## 2 Ordering information scheme

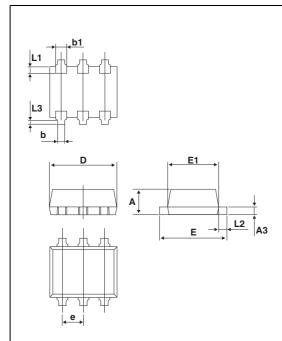


577

# 3 Package information

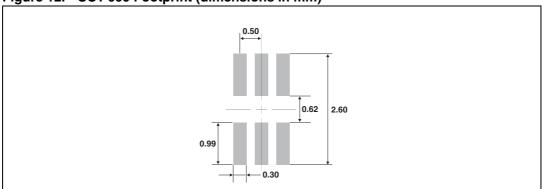
Epoxy meets UL94, V0

Table 3. SOT-666 Dimensions



	Dimensions							
Ref.	Millimete		ers		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	0.45		0.60	0.018		0.024		
А3	0.08		0.18	0.003		0.007		
b	0.17		0.34	0.007		0.013		
b1	0.19	0.27	0.34	0.007	0.011	0.013		
D	1.50		1.70	0.059		0.067		
Е	1.50		1.70	0.059		0.067		
E1	1.10		1.30	0.043		0.051		
е		0.50			0.020			
L1		0.19			0.007			
L2	0.10		0.30	0.004		0.012		
L3	_	0.10			0.004			

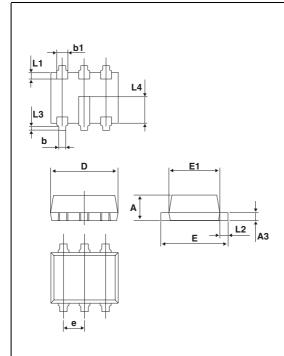
Figure 12. SOT-666 Footprint (dimensions in mm)



57

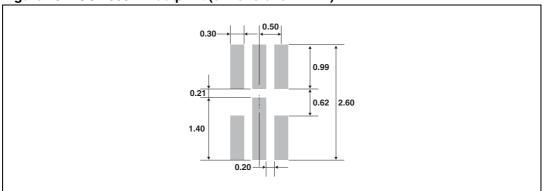
Package information ESDAxxxP6

Table 4. SOT-666IP Dimensions



	Dimensions						
Ref.	Millimete		ers		Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.45		0.60	0.018		0.024	
А3	0.08		0.18	0.003		0.007	
b	0.17		0.34	0.007		0.013	
b1	0.19	0.27	0.34	0.007	0.011	0.013	
D	1.50		1.70	0.059		0.067	
Е	1.50		1.70	0.059		0.067	
E1	1.10		1.30	0.043		0.051	
е		0.50			0.020		
L1		0.19			0.007		
L2	0.10		0.30	0.004		0.012	
L3		0.10			0.004		
L4		0.60			0.024		

Figure 13. SOT-666IP Footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

6/8

# 4 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
ESDA6V1P6	В	SOT-666IP			
ESDA6V1-5P6	С	301-00015	2.9 mg	3000	Tape and reel
ESDA14V2BP6	Α	SOT-666	2.9 mg	3000	Tape and Teel
ESDA25-4BP6	V				

# 5 Revision history

Date	Revision	Changes
07-Feb-2006	1	ESDA6V1P6, ESDA6V1-5P6 and ESDA14V2BP6: datasheets merged. ECOPACK statement added. Some curves combined.
26-Jun-2006	2	Reformatted to current standards. Modified package information to show both SOT-666 and SOT-666IP.
22-May-2007	3	Added product ESDA25-4BP6



#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

577

8/8